# The RF Sub-Micron MOSFET Line RF Power Field Effect Transistor N-Channel Enhancement-Mode Lateral MOSFET

Designed for PCN and PCS base station applications with frequencies from 1.9 to 2.0 GHz. Suitable for TDMA, CDMA and multicarrier amplifier

Typical 2-Carrier N-CDMA Performance for V<sub>DD</sub> = 26 Volts, I<sub>DQ</sub> = 1300 mA, f1 = 1958.75 MHz, f2 = 1961.25 MHz IS-95 CDMA (Pilot, Sync, Paging, Traffic Codes 8 Through 13) 1.2288 MHz Channel Bandwidth Carrier. Adjacent Channels Measured over a 30 kHz Bandwidth at f1 -885 kHz and f2 +885 kHz. Distortion Products Measured over 1.2288 MHz Bandwidth at f1 -2.5 MHz and f2 +2.5 MHz. Peak/Avg. = 9.8 dB @ 0.01% Probability on CCDF.

Output Power — 24 Watts Avg.

Power Gain — 13.6 dB

Efficiency — 22%

ACPR — -51 dB

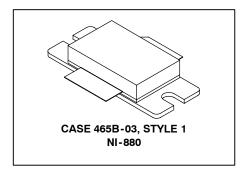
applications.

IM3 — -37.0 dBc

- · Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- · Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 5:1 VSWR, @ 26 Vdc, 1990 MHz, 125 Watts (CW) Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.

### MRF19125R3

1990 MHz, 125 W, 26 V LATERAL N-CHANNEL RF POWER MOSFET



#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	65	Vdc
Gate-Source Voltage	V <sub>GS</sub>	-0.5, +15	Vdc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	330 1.89	Watts W/°C
Storage Temperature Range	T <sub>stg</sub>	- 65 to +150	°C
Operating Junction Temperature	T <sub>J</sub>	200	°C

#### THERMAL CHARACTERISTICS

	Characteristic	Symbol	Value (1)	Unit
Ther	Thermal Resistance, Junction to Case		0.53	°C/W

#### **ESD PROTECTION CHARACTERISTICS**

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)

(1) Refer to AN1955/D, Thermal Measurement Methodology of RF Power Amplifiers. Go to <a href="http://www.motorola.com/semiconductors/rf">http://www.motorola.com/semiconductors/rf</a>. Select Documentation/Application Notes - AN1955.

NOTE - <u>CAUTION</u> - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.





Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					ı
Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0 Vdc, I <sub>D</sub> = 100 μAdc)	V <sub>(BR)DSS</sub>	65	_		Vdc
Gate-Source Leakage Current (V <sub>GS</sub> = 5 Vdc, V <sub>DS</sub> = 0 Vdc)	I <sub>GSS</sub>	_	_	1	μAdc
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 26 Vdc, V <sub>GS</sub> = 0 Vdc)	I <sub>DSS</sub>	_	_	10	μAdc
ON CHARACTERISTICS					
Forward Transconductance (V <sub>DS</sub> = 10 Vdc, I <sub>D</sub> = 3 Adc)	9fs	_	9	_	S
Gate Threshold Voltage (V <sub>DS</sub> = 10 Vdc, I <sub>D</sub> = 300 μAdc)	V <sub>GS(th)</sub>	2	_	4	Vdc
Gate Quiescent Voltage (V <sub>DS</sub> = 26 Vdc, I <sub>D</sub> = 1300 mAdc)	V <sub>GS(Q)</sub>	2.5	3.9	4.5	Vdc
Drain-Source On-Voltage (V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 3 Adc)	V <sub>DS(on)</sub>	_	0.185	0.21	Vdc
DYNAMIC CHARACTERISTICS			1		•
Reverse Transfer Capacitance (1) (V <sub>DS</sub> = 26 Vdc, V <sub>GS</sub> = 0, f = 1 MHz)	C <sub>rss</sub>	_	5.4	_	pF
FUNCTIONAL TESTS (In Motorola Test Fixture) 2-Carrier N-CDMA, 1.228 @ 0.01% Probability on CCDF.	8 MHz Chann	el Bandwidtl	n Carriers. Pe	ak/Avg = 9.8	dB
Common-Source Amplifier Power Gain (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 24 W Avg, I <sub>DQ</sub> = 1300 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	G <sub>ps</sub>	12	13.5	_	dB
Drain Efficiency (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 24 W Avg, I <sub>DQ</sub> = 1300 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	η	19	22	_	%
Intermodulation Distortion (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 24 W Avg, I <sub>DQ</sub> = 1300 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz; IM3 measured over 1.2288 MHz Bandwidth at f1 -2.5 MHz and f2 +2.5 MHz)		-	-37	-35	dBc
Adjacent Channel Power Ratio (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 24 W Avg, I <sub>DQ</sub> = 1300 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz; ACPR measured over 30 kHz Bandwidth at f1 -885 MHz and f2 +885 MHz)		_	-51	-47	dBc
Input Return Loss (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 24 W Avg, I <sub>DQ</sub> = 1300 mA, f1 = 1930 MHz, f2 = 1932.5 MHz and f1 = 1987.5 MHz, f2 = 1990 MHz)	IRL	_	-13	-9	dB
Output Mismatch Stress (V <sub>DD</sub> = 26 Vdc, P <sub>out</sub> = 125 W CW, I <sub>DQ</sub> = 1300 mA, f = 1930 MHz, VSWR = 5:1, All Phase Angles at Frequency of Test)	Ψ	No Degradation In Output Power Before and After Test			

<sup>(1)</sup> Part is internally matched both on input and output.

**ELECTRICAL CHARACTERISTICS** — continued ( $T_C = 25^{\circ}C$  unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
FUNCTIONAL TESTS (In Motorola Test Fixture)					
Two-Tone Common-Source Amplifier Power Gain $(V_{DD}=26\ Vdc,\ P_{out}=125\ W\ PEP,\ I_{DQ}=1300\ mA,\ f1=1930\ MHz,\ f2=1990\ MHz,\ Tone\ Spacing=100\ kHz)$	G <sub>ps</sub>	_	13.5	_	dB
Two-Tone Drain Efficiency $(V_{DD}=26~Vdc,~P_{out}=125~W~PEP,~I_{DQ}=1300~mA,~f1=1930~MHz,~f2=1990~MHz,~Tone~Spacing=100~kHz)$	η	_	35	_	%
Third Order Intermodulation Distortion ( $V_{DD}$ = 26 Vdc, $P_{out}$ = 125 W PEP, $I_{DQ}$ = 1300 mA, f1 = 1930 MHz, f2 = 1990 MHz, Tone Spacing = 100 kHz)	IMD	_	-30	_	dBc
Input Return Loss $(V_{DD}=26\ Vdc,\ P_{out}=125\ W\ PEP,\ I_{DQ}=1300\ mA,\ f1=1930\ MHz,\ f2=1990\ MHz,\ Tone\ Spacing=100\ kHz)$	IRL	_	-13	_	dB
P <sub>out</sub> , 1 dB Compression Point (V <sub>DD</sub> = 26 Vdc, I <sub>DQ</sub> = 1300 mA, f = 1990 MHz)	P1dB	_	130	_	W

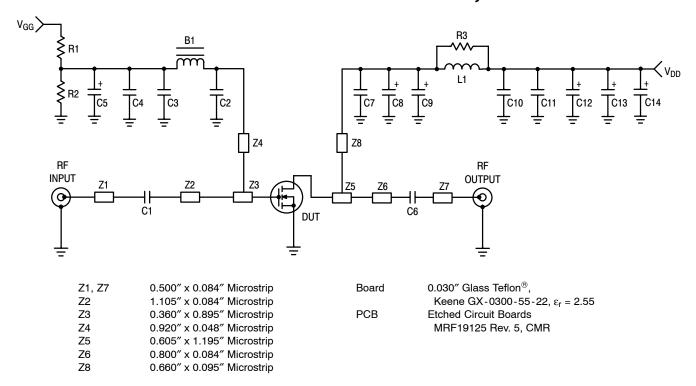


Figure 1. MRF19125 Test Circuit Schematic

Table 1. MRF19125 Test Circuit Component Designations and Values

Designators	Description		
B1	Short Ferrite Bead, Fair Rite #2743019447		
C1	51 pF Chip Capacitor, ATC #100B510JCA500X		
C2, C7	5.1 pF Chip Capacitors, ATC #100B5R1JCA500X		
C3, C10	1000 pF Chip Capacitors, ATC #100B102JCA500X		
C4, C11	0.1 μF Chip Capacitors, Kemet #CDR33BX104AKWS		
C5	0.1 μF Tantalum Chip Capacitor, Kemet #T491C105M050		
C6	10 pF Chip Capacitor, ATC #100B100JCA500X		
C8	10 μF Tantalum Chip Capacitor, Kemet #T491X106K035AS4394		
C9, C12, C13, C14	22 μF Tantalum Chip Capacitors, Kemet #T491X226K035AS4394		
L1	1 Turn, #20 AWG, 0.100" ID, Motorola		
N1, N2	Type N Flange Mounts, Omni Spectra #3052-1648-10		
R1	1.0 kΩ, 1/8 W Chip Resistor		
R2	220 kΩ, 1/8 W Chip Resistor		
R3	10 Ω, 1/8 W Chip Resistor		

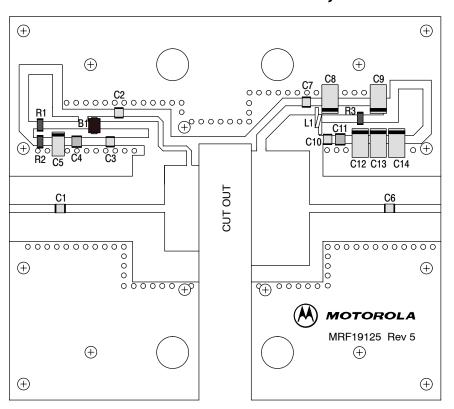


Figure 2. MRF19125 Test Circuit Component Layout

#### **TYPICAL CHARACTERISTICS**

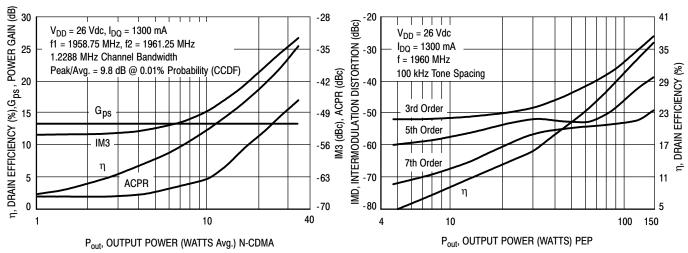


Figure 3. 2-Carrier CDMA ACPR, IM3, Power Gain and Drain Efficiency versus Output Power

Figure 4. Intermodulation Distortion Products versus Output Power

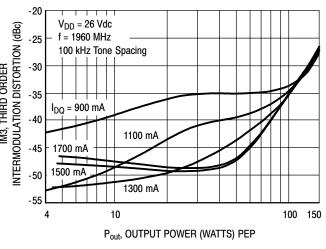


Figure 5. Third Order Intermodulation Distortion versus Output Power

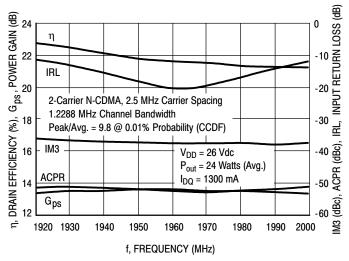


Figure 6. 2-Carrier N-CDMA Broadband Performance

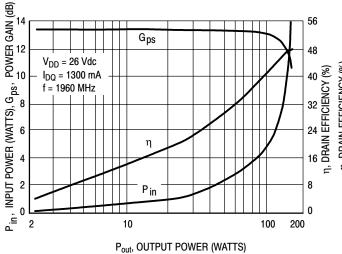


Figure 7. CW Performance

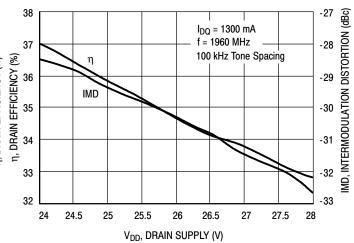


Figure 8. Two-Tone Intermodulation Distortion and Drain Efficiency versus Drain Supply

#### **TYPICAL CHARACTERISTICS**

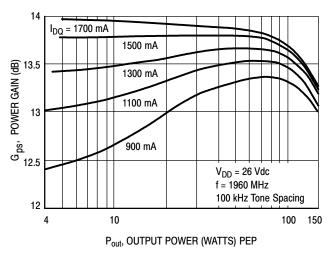


Figure 9. Two-Tone Power Gain versus
Output Power

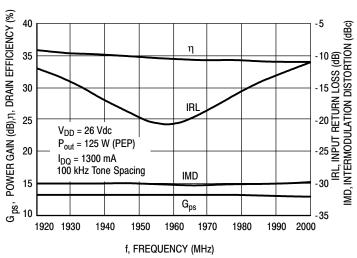


Figure 10. Two-Tone Broadband Performance

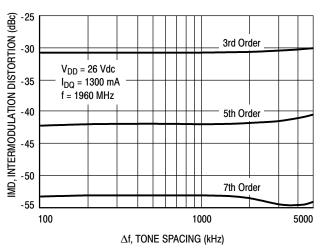


Figure 11. Intermodulation Distortion Products versus Two-Tone Tone Spacing

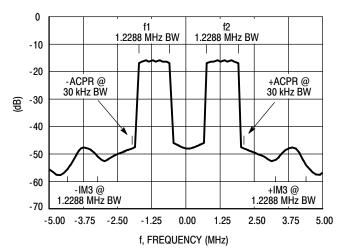
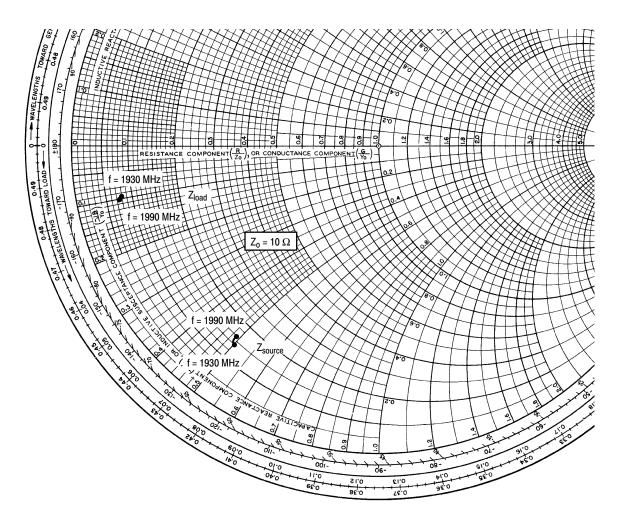


Figure 12. 2-Carrier N-CDMA Spectrum



 $V_{DD}$  = 26 V,  $I_{DQ}$  = 1300 mA,  $P_{out}$  = 24 W (Avg.)

f MHz	$\mathbf{Z_{source}}_{\Omega}$	$oldsymbol{Z_{load}}{\Omega}$
1930	1.43 - j5.01	0.75 - j0.93
1960	1.51 - j4.88	0.71 - j0.89
1990	1.56 - j4.93	0.68 - j1.02

Test circuit impedance as measured from gate to ground.

Test circuit impedance as measured  $Z_{load}$ from drain to ground.

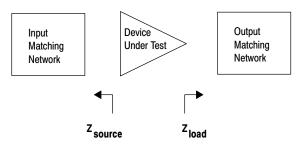
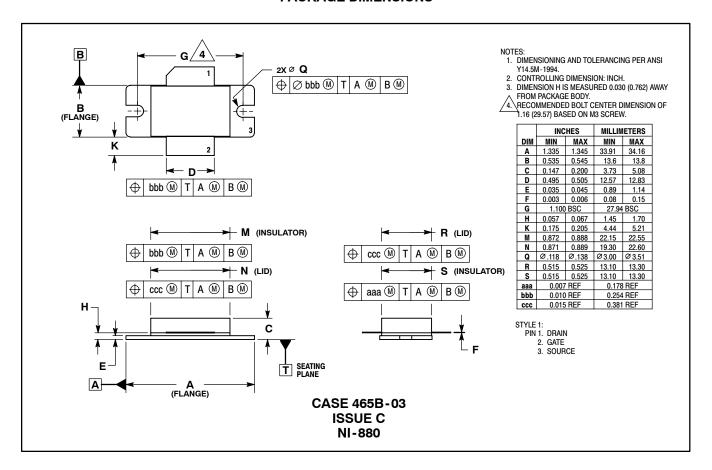


Figure 13. Series Equivalent Input and Output Impedance

#### PACKAGE DIMENSIONS



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